

AS1376 1A, Low Input Voltage, Low Quiescent Current LDO

General Description

The AS1376 is a dual supply rail linear regulator designed to deliver 1A of load current while consuming only $67\mu A$ (typ) of ground current. In the typical post regulation application VBIAS is directly connected to the main input supply, (range 2.5V ... 5.5V) and VIN is supplied by the output voltage of a host DC-DC converter (range 0.7V ... 4.5V).

The device offers excellent dropout (120mV @ 1A) and transient performance.

In shutdown (Enable pin pulled low), the device turns off and reduces quiescent current consumption to 10nA (typ) at both VBIAS and VIN terminals.

In shutdown, a 100Ω (typ) discharge path is connected between output and ground to provide rapid discharge of the overall load capacitance connected to the AS1376 output terminal. Auto-discharge minimizes the possibility that VOUT > VIN during shutdown. When VOUT > VIN, reverse current flows through the inherent body diode of the N-channel series pass transistor.

The AS1376 also features internal protection against over-temperature, over-current and under-voltage conditions.

The AS1376 is available in an 8-pin 2x2 TDFN package and AS1376B is available in a 6-balls WL-CSP. Both package options are qualified for operation over the -40°C to 85°C temperature range.

Ordering Information and Content Guide appear at end of datasheet.



Key Benefits & Features

The benefits and features of this device are listed below:

Figure 1: Added Value of Using AS1376

Benefits	Features
 Less internal voltage losses and minimized self-heating 	Ultra-Low Dropout Voltage: <120mV @ 1A load
Supports a variety of low voltage end applications	Output Voltage from 0.5V to 3.3V
Ideal as follower of a buck converter	Input Voltage from 0.7V to 3.6V
 Independent bias supply ensures more robustness due to heavy load changes 	Bias Supply Voltage from 2.5V to 5.5V
Supports a variety of high load applications	Maximum Output Current up to 1A
Cost effective, small package	 8-pin TDFN 2x2mm package 6-balls WL-CSP with 0.4mm pitch

Applications

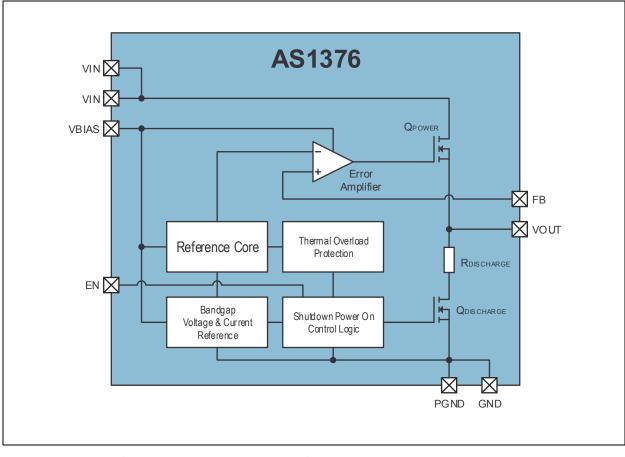
The devices are ideal for powering cordless and mobile phones, MP3 players, CD and DVD players, PDAs, hand-held computers, digital cameras and any other hand-held and/or battery-powered device.



Block Diagram

The functional blocks of this device are shown below:

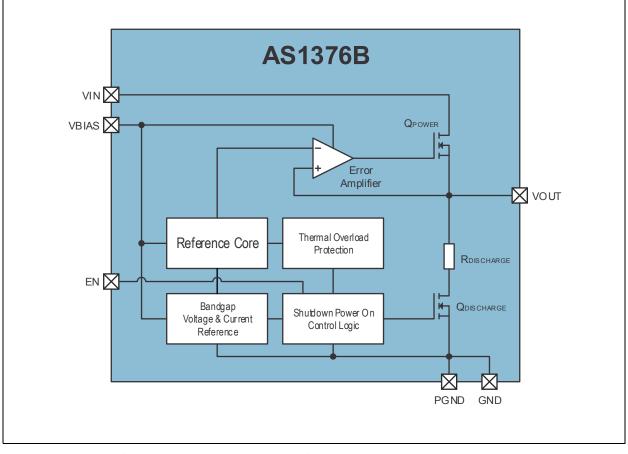




Block Diagram: This figure shows the block diagram of AS1376



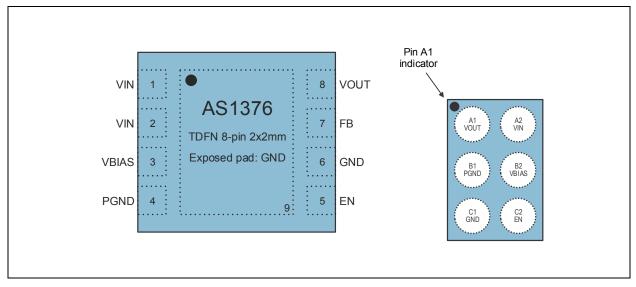
Figure 3: Functional Blocks of AS1376B



Block Diagram: This figure shows the block diagram of AS1376B

Pin Assignments

Figure 4: Pin Diagram of AS1376 and AS1376B



Pin Assignment: These figures show the top view pin assignment of AS1376 in 8-pin TDFN package and AS1376B in 6-balls WL-CSP.

Figure 5: Pin Description of AS1376 and AS1376B

Pin I	Number	Pin	
8-Pin TDFN (AS1376)	6-Pin WL-CSP (AS1376B)	Name	Description
1,2	A2	VIN	Unregulated Input Voltage. 0.6V to 3.6V. Bypass this pin with a capacitor to GND
3	B2	VBIAS	Bias Input Voltage. 2.5V to 5.5V. Bypass this pin with a capacitor to GND
4	B1	PGND	Power Ground. This pin must be connected directly to the GND plane and must not be left open!
5	C2	EN	Enable. Pull this pin low to disable the device
6	C1	GND	Ground. This pin must be connected directly to the GND plane and must not be left open!
7	-	FB	Feedback Pin. Connect to VOUT to select the factory preset output voltage. For the adjustable version connect to an external resistor divider to set the output voltage
8	A1	VOUT	Regulated Output Voltage. 0.5V to 3.3V. Bypass this pin with a capacitor to GND
9	-		Exposed Pad. This pad is not connected internally. Ensure a good connection to the PCB to achieve optimal thermal performance. Ideally connect it to GND plane.

Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under Electrical Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 6:

Absolute Maximum Ratings of AS1376

Symbol	Parameter	Min	Мах	Units	Comments			
Electrical Parameters								
	VIN to GND	-0.3	5.0	V	Applicable for pin: VIN			
	VBIAS, EN to GND	-0.3	6.5	V	Applicable for pins: VBIAS, EN			
	VOUT to GND	-0.3	VIN + 0.3	V	Applicable for pin: VOUT			
	Output Short-Circuit Duration		Indefinite					
I _{SCR}	Input Current (latch-up immunity)	=	± 100	mA	JEDEC JESD78D Nov 2011			
	Continu	ious Pow	er Dissipatio	on (T _A = 7	0°C)			
P _T ⁽¹⁾	Continuous power		0.6	W	WL-CSP			
L ^L , ,	dissipation		1.5	W	TDFN			
		Electro	static Discha	arge				
ESD _{HBM}	Electrostatic Discharge HBM	±	1000	V	JS-001-2014			
	Temperat	ure Rang	ges and Stor	age Cond	litions			
T _A	Operating Ambient Temperature	-40	85	°C				
R _{THJA} ⁽¹⁾	Junction to Ambient		95	°C/W	WL-CSP			
ALHT	Thermal Resistance	36		°C/W	TDFN			
Tj	Operating Junction Temperature		125	°C				
T _{STRG}	Storage Temperature	-55	125	°C	WL-CSP			
'SIRG	Range	-55	150	°C	TDFN			

Symbol	Parameter	Min	Мах	Units	Comments		
			260	°C	WL-CSP	IPC/JEDEC J-STD-020 ⁽²⁾	
T _{BODY}	Package Body Temperature		260	°C	TDFN	IPC/JEDEC J-STD-020 ⁽²⁾ The lead finish for Pb-free leaded packages is "Matte Tin" (100% Sn)	
RH _{NC}	Relative Humidity (non-condensing)	5	85	%			
MSL Moisture Sensitivity Level			1		WL-CSP	Represents an unlimited floor time	
IVISE	MSL MOBULE Sensitivity Level		1		TDFN	Represents an unlimited floor time	

Note(s):

1. Depending on actual PCB layout and PCB used

2. The reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 "Moisture/Reflow Sensitivity Classification for Non-hermetic Solid State Surface Mount Devices".



Electrical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

Figure 7: Electrical Characteristics of AS1376

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
V _{IN}	Input Voltage		0.7		3.6	V	
V _{BIAS}	Bias Supply Voltage		2.5		5.5	V	
V _{OUT}	Output Voltage	Available in 100mV steps	0.5		3.3	V	
V _{OUT_nom}		I _{OUT} = 100uA	-1.5		+1.5	%	
- V _{OUT}	Output Voltage Accuracy	I _{OUT} = 0A to 1A	-2		+2	- %	
V		I _{OUT} = 100uA	492	500	508	mV	
V _{FB}	Feedback Voltage ⁽¹⁾	I _{OUT} = 0A to 1A	490	500	510	mV	
∆V _{OUT} / ∆V _{IN}	Line Regulation V _{IN}	I _{OUT} = 100uA		40		uV/V	
∆V _{OUT} / ∆V _{BIAS}	Line Regulation V _{BIAS}	I _{OUT} = 100uA		135		uV/V	
∆V _{OUT} / ∆I _{OUT}	Load Regulation	I _{OUT} = 1mA to 1A		0.0002		%/mA	
I _{OUT}	Output Current ⁽²⁾		1			А	
I _{LIM}	Current Limit	V _{OUT} forced to 90% of nominal V _{OUT}		1.35		А	
		$V_{BIAS} = V_{OUT} + 1.5V, I_{OUT} = 1A$		120			
V _{DROP} _	Output Voltage Dropout	$V_{BIAS} = V_{OUT} + 1.8V, I_{OUT} = 1A$		115			
VIN	VIN	$V_{BIAS} = V_{OUT} + 2.1V$, $I_{OUT} = 1A$		110		mV	
		$V_{BIAS} = 5.5V, I_{OUT} = 1A$		105		1	
V _{DROP}	Output Voltage Dropout	I _{OUT} = 500mA		0.85		V	
VBIAS	VBIAS	I _{OUT} = 1A		1.1		- V	
e _N	Output Voltage Noise	$f = 10Hz$ to 100kHz, $I_{OUT} = 1mA$		65		uV _{RMS}	

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
		f = 100Hz, I _{OUT} = 10mA		78			
PSRR_	Power Supply Rejection Ratio Sine modulated	f = 1kHz, I _{OUT} = 10mA		61		dB	
VIN	V VIN	f = 10kHz, I _{OUT} = 10mA		54			
		f = 100kHz, I _{OUT} = 10mA		60			
		f = 100Hz, I _{OUT} = 10mA		69			
PSRR_	Power Supply Rejection Ratio Sine modulated	f = 1kHz, I _{OUT} = 10mA		51		dB	
VBIAS	VBIAS	f = 10kHz, I _{OUT} = 10mA		45		ЧD	
		f = 100kHz, I _{OUT} = 10mA		45			
I _{Q_VBIAS}	Quiescent Current into VBIAS			60	120	uA	
I _{Q_VIN}	Quiescent Current into VIN	I _{OUT} = 0mA		6.5	8	uA	
I _{SHDN_} VBIAS	Shutdown Current into VBIAS	EN = 0V		0.02		uA	
I _{SHDN_VIN}	Shutdown Current into VIN	EN = 0V		0.02		uA	
I _{EN}	Enable Input Bias Current			0.001	1	uA	
V _{IH}	Enable Input Threshold	V _{IN} = 0.7 to 3.6V	1		V _{BIAS}	V	
V _{IL}	Enable Input Threshold	VIN - 0.7 10 5.0V			0.4	v	
T _{SHDN}	Thermal Shutdown Temperature			155		°C	
ΔT_{SHDN}	Thermal Shutdown Hysteresis			30		°C	
∆V _{OUT}	Dynamic Load Transient Response VBIAS			±35		mV	
t _{ON}	Exit Delay from Shutdown	Settling to 95%, no Load		72		us	
С _{ОИТ}	Output Capacitor	Load Capacitor Range	1		10	uF	
~001		Maximum ESR Load			500	mΩ	

Electrical Characteristics: $V_{IN} = V_{OUT} + 0.2V$, $V_{BIAS} = V_{OUT} + 1.5V$ (or 2.5V whichever is larger), $EN = V_{BIAS}$, $C_{IN} = C_{OUT} = 1$ uF, $C_{BIAS} = 4.7$ uF, $T_{AMB} = -40^{\circ}$ C to 85°C. Typical values are at $T_{AMB} = 25^{\circ}$ C (unless otherwise specified)

Note(s):

1. Valid only for AS1376-BTDT-AD (adjustable output versions)

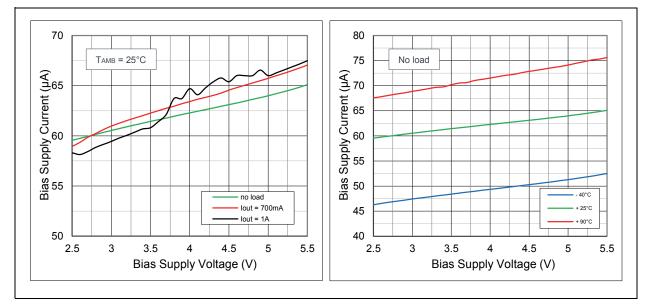
2. Limit guaranteed by design and characterization



Typical Operating Characteristics

Figure 8:

Bias Supply Current vs. Bias Supply Voltage



Bias Supply Current vs. Bias Supply Voltage: $V_{IN} = 1.2V$, $EN = V_{BIAS}$, $V_{OUT} = 1.0V$, $C_{IN} = C_{OUT} = 1$ uF, $C_{BIAS} = 4.7$ uF

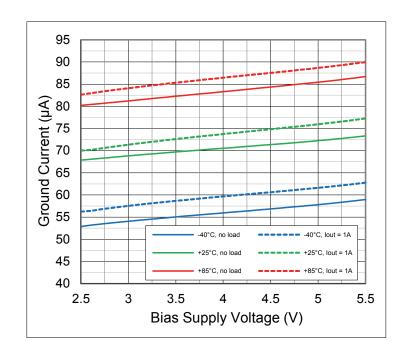


Figure 9: GND Current vs. Bias Supply Voltage

GND Current vs. Bias Supply Voltage: VIN = 1.2V, EN = VBIAS, VOUT = 1.0V, CIN = COUT = 1uF, CBIAS = 4.7uF



Figure 10: GND Current vs. Load Current



$$\label{eq:VIN} \begin{split} \text{VIN} &= 1.2 \text{V}, \text{EN} = \text{VBIAS}, \text{VOUT} = 1.0 \text{V}, \\ \text{CIN} &= \text{COUT} = 1 \text{uF}, \text{CBIAS} = 4.7 \text{uF} \end{split}$$

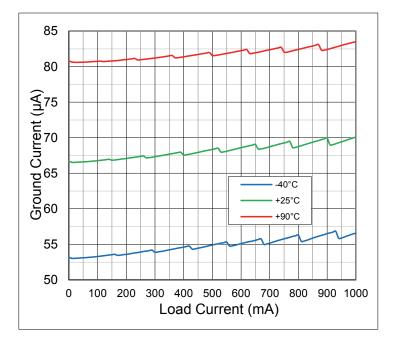
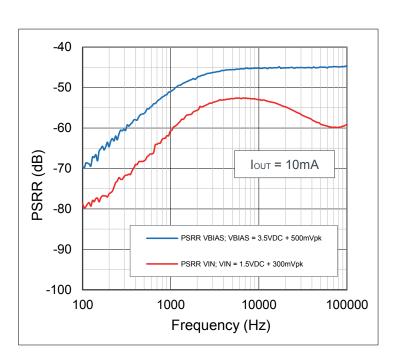


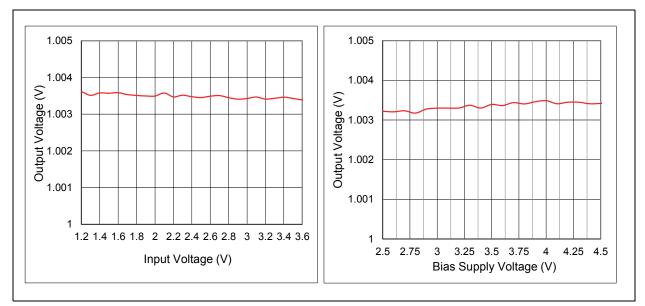
Figure 11: PSRR vs. Frequency



PSRR vs. Frequency: PSRRVIN(EN = VBIAS = 2.5V, VOUT = 1.0V, no CIN, COUT = CBIAS = 1uF, RLOAD = 100 Ω); PSRRVBIAS (EN = VIN = 1.2V, VOUT = 1.0V, CIN = COUT = 1uF, no CBIAS, RLOAD = 100 Ω)



Figure 12: Line Regulation



Line Regulation: LNRVIN (EN = VBIAS = 2.5V, VOUT = 1.0V, CIN = COUT = 1uF, CBIAS = 4.7uF, IOUT = 100uA); LNRVBIAS (EN = VBIAS, VIN = 1.2V, VOUT = 1.0V, CIN = COUT = 1uF, CBIAS = 4.7uF, IOUT = 100uA)



Load Regulation: EN = VBIAS = 2.5V, VIN = 1.2V, VOUT = 1.0V, CIN = COUT = 1uF, CBIAS = 4.7uF

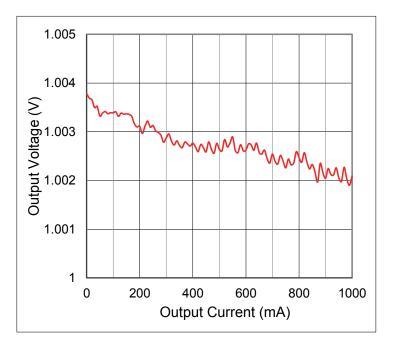




Figure 14: Output Voltage vs. Temperature

Output Voltage vs. Temperature:

EN = VBIAS = 2.5V, VIN = 1.2V,VOUT = 1.0V, CIN = COUT = 1uF,CBIAS = 4.7uF, IOUT = 1mA

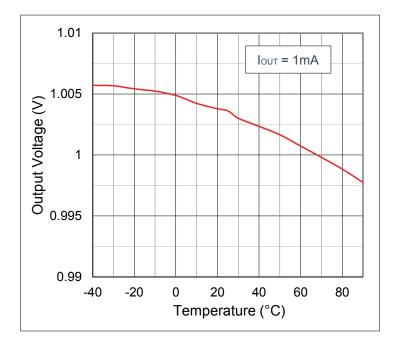
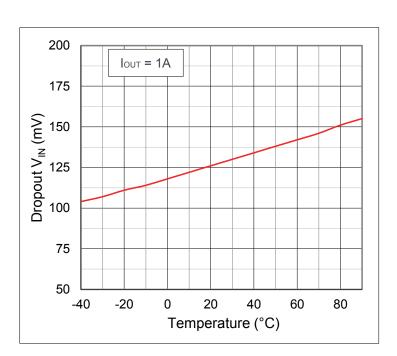


Figure 15: Dropout V_{IN} vs. Temperature



Dropout V_{IN} vs. Temperature:

$$\label{eq:stars} \begin{split} &\mathsf{EN}=\mathsf{VBIAS}=2.5\mathsf{V}, \ &\mathsf{VIN}=1.2\mathsf{V},\\ &\mathsf{VOUT}=1.0\mathsf{V}, \ &\mathsf{CIN}=\mathsf{COUT}=1\mathsf{uF},\\ &\mathsf{CBIAS}=4.7\mathsf{uF}, \ &\mathsf{IOUT}=1\mathsf{A} \end{split}$$



Figure 16: Enable Start-Up

Enable Start-Up: EN = VBIAS = 2.5V, VIN = 1.2V, settling to 95% of VOUT (950mV), CIN = COUT = 1uF, CBIAS = 4.7uF, no load

· · · · · · · · · · · · · · · · · · ·			500mV/Div
······································		· · ·	· · ·
EN			
- · ·			· · · · · · · · · · · · · · · · · · ·
			500mV/Div
······································			
VOUT		/	
· · · ·	 50us/Div		

Detailed Description

The AS1376 is a low-dropout, low-quiescent-current linear regulator intended for LDO regulator applications where output current load requirements range from no load to 1A. All devices come with fixed output voltage from 0.5V to 3.3V.

Shutdown current for the whole regulator is typically 20nA. The device has integrated short-circuit and over current protection. Under-Voltage lockout prevents erratic operation when the input voltage is slowly decaying (e.g. in a battery powered application). Thermal Protection shuts down the device when die temperature reaches 150°C. This is a useful protection when the device is under sustained short circuit conditions.

As illustrated in the block diagram on page 3, the devices comprise voltage reference, error amplifier, N-channel MOSFET pass transistor, internal voltage divider, current limiter, thermal sensor and shutdown logic.

The bandgap reference is connected to the inverting input of the error amplifier. The error amplifier compares this reference with the feedback voltage and amplifies the difference. If the feedback voltage is lower than the reference voltage, the N-channel MOSFET gate is pulled higher, allowing more current to pass to the output, and increases the output voltage. If the feedback voltage is too high, the pass-transistor gate is pulled down, allowing less current to pass to the output.

When the adjustable output variant is selected, an external resistor voltage divider is connected to FB pin and a sample of the output is compared to the 500mV reference.

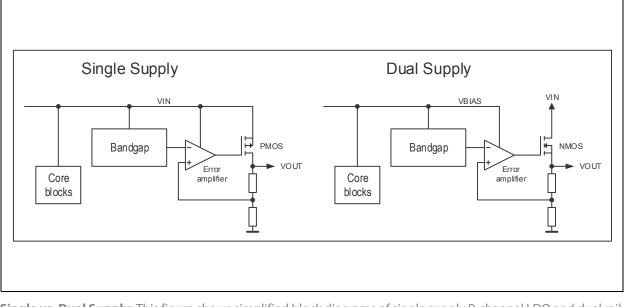
When a fixed output variant is chosen, FB must be connected to the Output pin. Depending upon the variant chosen, the internal reference is trimmed to the final output voltage.

Advantage of Dual Supply Architecture vs. Traditional Single Supply Approach

Compared to the traditional single supply approach, employing a P-channel series pass MOSFET, the dual rail architecture ensures improved performances in a LDO when operating at very low input voltages below the threshold of the internal series power N-channel MOSFET. The extra supply voltage at pin VBIAS ($V_{BIAS} > V_{IN}$) ensures that the N-channel MOSFET always operates above its threshold voltage.



Figure 17: Single vs. Dual Supply



Single vs. Dual Supply: This figure shows simplified block diagrams of single supply P-channel LDO and dual rail N-channel series pass architectures.

The P-channel LDO uses a PMOS output transistor connected in a common source configuration. During regulation, the PMOS

gate-source voltage moves between VIN and GND as the load demands. The dual supply approach is based on a NMOS output transistor in common drain configuration where the source is connected to the regulated output. During regulation, the NMOS gate source voltage increases from VOUT to VBIAS as the load demands. As the drain voltage is not shared with the remaining blocks of the circuit, its value can be chosen independently. The NMOS source follower design allows improved efficiency and dropout at low input voltages and provides faster load transient response.

Dropout Voltage

Dropout is the input to output voltage difference, below which the linear regulator ceases to regulate. At this point, the output voltage change follows the input voltage change. Dropout voltage may be measured at different currents and, in particular at the regulator maximum one. From this is obtained the MOSFET maximum series resistance over temperature.

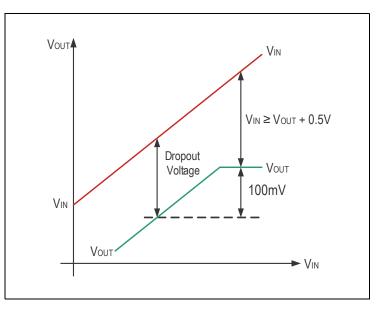
(EQ1) $V_{DROPOUT} = I_{LOAD} * R_{SERIES}$

Dropout is probably the most important specification when the regulator is used in a battery application. The dropout performance of the regulator defines the useful "end of life" of the battery before replacement or re-charge is required.



Figure 18: Graphical Representation of Dropout Voltage

Dropout Voltage: This figure shows the variation of VOUT as VIN is varied for a certain load current. The practical value of dropout is the differential voltage (VOUT - VIN) measured at the point where the LDO output voltage has fallen by 100mV below the nominal, fully regulated output value. The nominal regulated output voltage of the LDO is that obtained when there is 500mV (or greater) input-output voltage differential.



Auto-Discharge

AS1376 features an auto-discharge function that discharges the load capacitance through a 100Ω (typ) path to ground when the device is placed in shutdown. This helps to minimizes the possibility that VOUT> VIN during shutdown caused by differing capacitance discharge rates at VIN and VOUT terminals. When VOUT> VIN, reverse current flows through the inherent body diode of the NMOS series pass transistor. This current should be limited to 50mA or less. If this is not possible, then an external Schottky diode should be connected between VOUT (anode) and VIN (cathode) to bypass the discharge current around the AS1376.

Efficiency

Low quiescent current and low input-output voltage differential are important in battery applications amongst others, as the regulator efficiency is directly related to quiescent current and dropout voltage.

(EQ2) Efficiency =
$$\frac{V_{LOAD} \times I_{LOAD}}{V_{IN} \cdot (I_{Q} + I_{LOAD})} \times 100\%$$

IQ... Quiescent current of LDO measured at VBIAS

Power Dissipation

Maximum power dissipation (PD) of the LDO is the sum of the power dissipated by the internal series MOSFET and the quiescent current required to bias the internal voltage reference and the internal error amplifier.

(EQ3) $PD_{(MAX)}(Seriespass) = I_{LOAD(MAX)} * (V_{IN(MAX)} - V_{OUT(MIN)})$

Internal power dissipation as a result of the bias current for the internal voltage reference and the error amplifier is calculated as:

(EQ4) $PD_{(MAX)}(Bias) = V_{IN(MAX)} * I_Q$

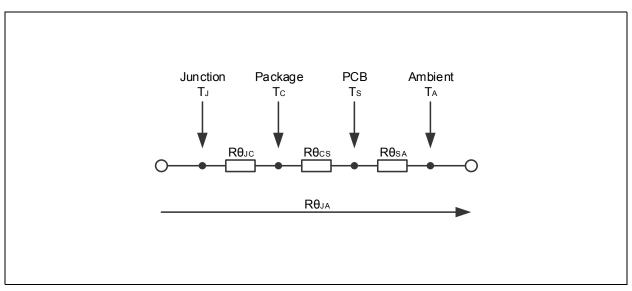
Total LDO power dissipation is calculated as:

(EQ5) $PD_{(MAX)}(TOTAL) = PD_{(MAX)}(Seriespass) + PD_{(MAX)}(Bias)$

Junction Temperature

Under all operating conditions, the maximum junction temperature should not exceed 125°C (unless the data sheet specifically allows). Limiting the maximum junction temperature requires knowledge of the heat path from junction to case (θ_{JC} °C/W fixed by the IC manufacturer), and adjustment of the case to ambient heat path (θ_{CA} °C/W) by manipulation of the PCB copper area adjacent to the IC position.

Figure 19: Steady State Heat Flow Equivalent Circuit



Total Thermal Path Resistance

$$(EQ6) \quad R\theta_{JA} = R\theta_{JC} + R\theta_{CS} + R\theta_{SA}$$

Junction Temperature (T_J°C) is determined by:

$$(EQ7) T_J = (PD_{(MAX)} * R\theta_{JA}) + T_{AMB}$$

Explanation of Steady State Specifications

Line Regulation

Line regulation is defined as the change in output voltage when the input voltage is changed by a known quantity. It is a measure of the regulator's ability to maintain a constant output voltage when the input voltage changes. Line regulation is a measure of the DC open loop gain of the error amplifier.

$$(EQ8) \quad LNR = \frac{\Delta V_{OUT}}{\Delta V_{IN}}$$

In practice, line regulation is referred to the regulator output voltage in terms of %/VOUT. This is particularly useful when the same regulator is available with numerous output voltage trim options.

$$(EQ9) \quad LNR = \frac{\Delta V_{OUT}}{\Delta V_{IN}} * \frac{100}{V_{OUT}} \%$$

Load Regulation

Load regulation is defined as the change of the output voltage when the load current is changed by a known quantity. It is a measure of the regulator's ability to maintain a constant output voltage when the load changes. Load regulation is a measure of the DC closed loop output resistance of the regulator.

(EQ10) LDR =
$$\frac{\Delta V_{OUT}}{\Delta I_{OUT}}$$

In practice, load regulation is referred to the regulator output voltage in terms of %/mA. This is particularly useful when the same regulator is available with numerous output voltage trim options.

(EQ11)
$$LDR = \frac{\Delta V_{OUT}}{\Delta I_{OUT}} * \frac{100}{V_{OUT}} \%$$

Output Voltage Setting

For the adjustable Output Voltage version the final output voltage can be calculated by the ratio of R_{UP} and R_{DN} , the internal reference voltage (= FB voltage) and the input offset voltage of the error amplifier.

(EQ12)
$$V_{OUT} = (V_{FB}) \times \left(1 + \frac{R_{UP}}{R_{DN}}\right) - R_{UP} \times 0.45 \mu A$$

Total Accuracy

Away from dropout, total steady state accuracy is the sum of setting accuracy, load regulation and line regulation.

(EQ13) Accuracy_{Total} = Accuracy_{Setting} + LDR + LNR

Explanation of Dynamic Specifications

Power Supply Rejection Ratio (PSRR)

Known also as Ripple Rejection, this specification measures the ability of the regulator to reject noise and ripple beyond DC. PSRR is a summation of the individual rejections of the error amplifier, reference and AC leakage through the series pass transistor. The specification, in the form of a typical attenuation plot with respect to frequency, shows up the gain bandwidth compromises forced upon the designer in low quiescent current conditions.

(EQ14) PSRR =
$$20\log \frac{\delta V_{OUT}}{\delta V_{IN}}$$

Power supply rejection ratio is fixed by the internal design of the regulator. Additional rejection must be provided externally.

Output Capacitor ESR

The series regulator is a negative feedback amplifier, and as such is conditionally stable. The ESR of the output capacitor is usually used to cancel one of the open loop poles of the error amplifier in order to produce a single pole response. Excessive ESR values may actually cause instability by excessive changes to the closed loop unity gain frequency crossover point. The range of ESR values for stability is usually shown either by a plot of stable ESR versus load current, or a limit statement in the datasheet.

Some ceramic capacitors exhibit large capacitance and ESR variations with temperature and DC bias. Z5U and Y5V capacitors may be required to ensure stability at temperatures below T_{AMB} = -10°C. With X7R or X5R capacitors, a 1µF capacitor should be sufficient at all operating temperatures.

Larger output capacitor values ($10\mu F$ max) help to reduce noise and improve load transient-response, stability and power-supply rejection.

Input Capacitor

If the AS1376 is used stand alone, an input capacitor at VIN is required for stability. It is recommended to connect a 1μ F capacitor between the AS1376 power supply input pin VIN and GND (capacitance value may be increased without limit).

This capacitor must be located as close as possible to the VIN pin and returned to a clean analog ground. A X5R or X7R type or better may be used at the input.

A capacitor at VBIAS is not required if the distance to the supply does not exceed 5cm.



Noise

The regulator output is a DC voltage with noise superimposed on the output. The noise comes from three sources; the reference, the error amplifier input stage, and the output voltage setting resistors. Noise is a random fluctuation and if not minimized in some applications, will produce system problems.

Transient Response

The series regulator is a negative feedback system, and therefore any change at the output will take a finite time to be corrected by the error loop. This "propagation time" is related to the bandwidth of the error loop. The initial response to an output transient comes from the output capacitance, and during this time, ESR is the dominant mechanism causing voltage transients at the output.

 $(EQ15) \quad \delta V_{TRANSIENT} = \delta I_{OUTPUT} \times R_{ESR}$

Thus an initial +50mA change of output current will produce a -12mV transient when the ESR=240m Ω . Remember to keep the ESR within stability recommendations when reducing ESR by adding multiple parallel output capacitors.

After the initial ESR transient, there follows a voltage droop during the time that the LDO feedback loop takes to respond to the output change. This drift is approx. linear in time and sums with the ESR contribution to make a total transient variation at the output.

(EQ16)
$$\delta V_{\text{TRANSIENT}} = \delta I_{\text{OUTPUT}} \times \left(R_{\text{ESR}} + \frac{T}{C_{\text{LOAD}}} \right)$$

CLOAD... Output Capacitor

T ... Propagation Delay of the LDO

This shows why it is convenient to increase the output capacitor value for a better support for fast load changes. Of course the formula holds for t < "propagation time", so that a faster LDO needs a smaller cap at the load to achieve a similar transient response. For instance 50mA load current step produces 50mV output drop if the LDO response is 1usec and the load cap is 1µF.

There is also a steady state error caused by the finite output impedance of the regulator. This is derived from the load regulation specification discussed above.

Exit from Shutdown Delay

This specification defines the time taken for the LDO to awake from shutdown. The time is measured from the release of the enable pin to the time that the output voltage is within 5% of the final value. It assumes that the voltage at VIN is stable and within the regulator min and max limits. Shutdown reduces the quiescent current to very low, mostly leakage values (<1 μ A).

Thermal Protection

To prevent operation under extreme fault conditions, such as a permanent short circuit at the output, thermal protection is built into the device. Die temperature is measured, and when a 150°C threshold is reached, the device enters shutdown. When the die cools sufficiently, the device will restart (assuming input voltage exists and the device is enabled). Hysteresis of 25°C prevents low frequency oscillation between start-up and shutdown around the temperature threshold.

Power Supply Sequencing

The AS1376 requires two different supply voltages active at the same time for correct operation.

- V_{IN}: Input Supply Voltage
- V_{BIAS}: Bias Supply Voltage

It's important that VIN does not exceed VBIAS at any time. If the device is used in the typical post regulation application as shown in Figure 20, the sequencing of the two power supplies is not an issue as VBIAS supplies both, the DC-DC regulator and the AS1376. The output voltage of the DC-DC regulator will take some time to rise up and supply VIN of AS1376. In this application VIN will always ramp up more slowly than VBIAS. In case VIN is shorted to VBIAS, the voltages at the two supply pins will ramp up simultaneously causing no problem. Only in applications with two independent supplies connected to the AS1376 special care must be taken to guarantee that VIN is always $\leq V_{BIAS}$.

Auto Discharge

When the AS1376 is placed in shutdown, a 100Ω path to ground is connected at the output. This path speeds up the discharge of the capacitor(s) connected to the regulator output. Assuming that VIN remains constant and always >VOUT, output discharge time is calculated as follows:

(EQ17)
$$V(t) = V_{REG} \times e^{-\frac{t}{RC}}$$

t... specified time after regulator shutdown (sec)

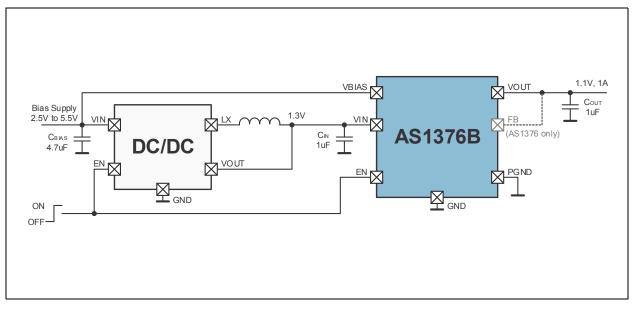
VREG... Regulated Output Voltage (initial condition)

- R ... 100 Ω (typ) discharge resistor
- C ... Output Capacitor (F)



Application Information

Figure 20: Typical Application Diagram



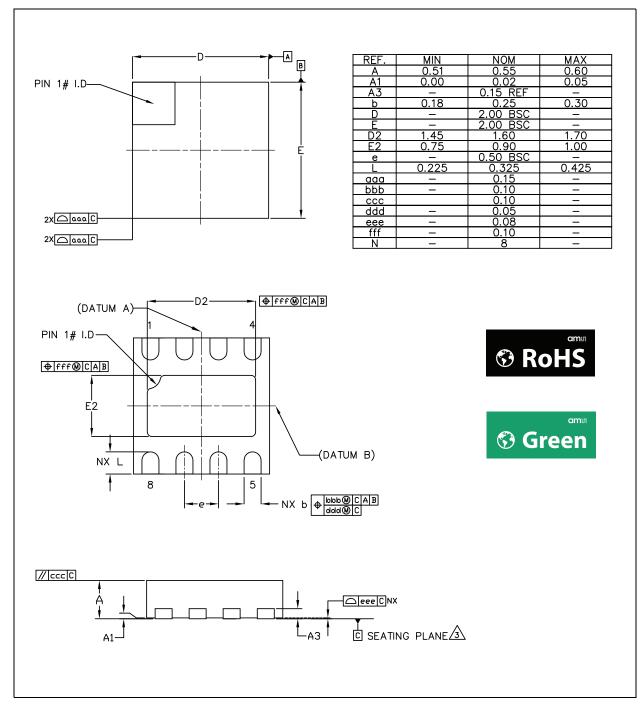
Typical Application: This figure shows the typical application of the AS1376B for the 6-pin WL-CSP. The FB pin and the dotted line would be valid only for the AS1376 TDFN version



Package Drawings & Markings

Figure 21:

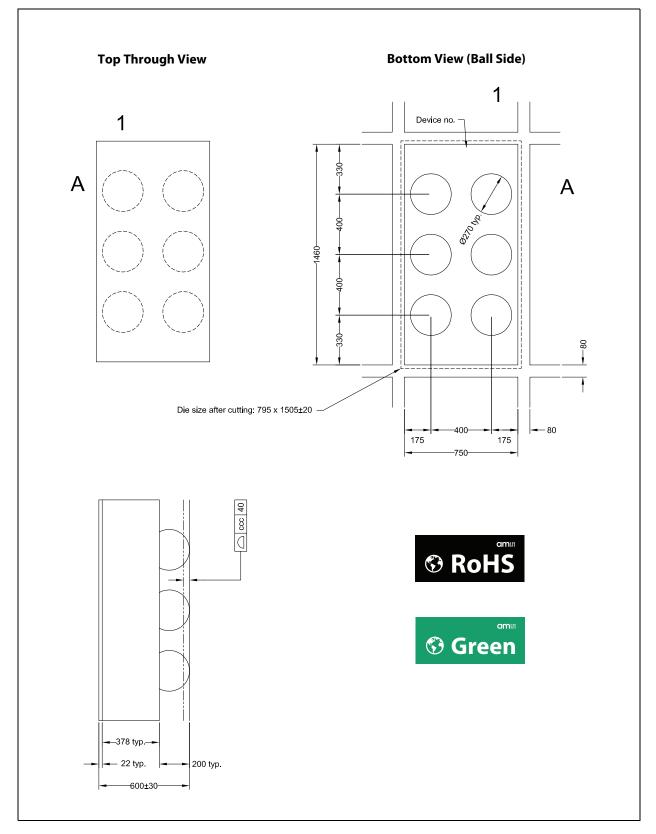
MLPD-8 2x2 0.5mm Pitch Package Drawing



Note(s):

- 1. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
- 2. All dimensions are in millimeters. Angles are in degrees.
- 3. Coplanarity applies to the exposed heat slug as well as the terminal.
- 4. Radius on terminal is optional.
- 5. N is the total number of terminals.

Figure 22: WL-CSP-6 0.4mm Pitch Package Drawing



Note(s):

1. Pin 1 = A1

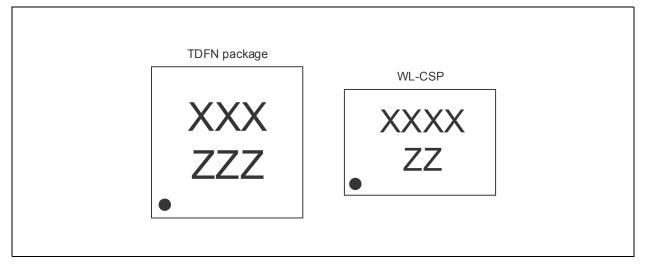
2. ccc Coplanarity

3. All dimensions are in μm .

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Figure 23: TDFN and WL-CSP Marking



AS1376 Marking: Shows the package marking of the TDFN and the WL-CSP product version

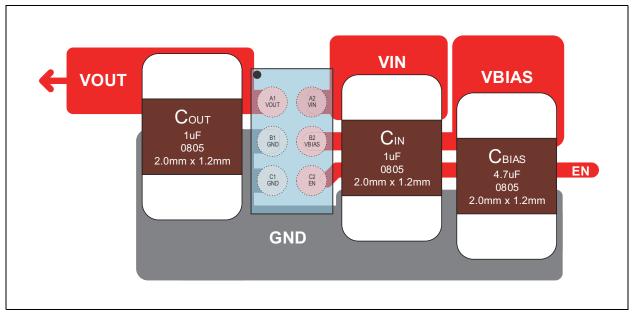
Figure 24: Package Code

XXX	ZZZ	хххх	ZZ
Tracecode for TDFN	Marking Code for TDFN	Tracecode for WL-CSP	Marking Code for WL-CSP

Package Codes: Shows the package codes of the TDFN and the WL-CSP product version

PCB Pad Layout

Figure 25: PCB Layout Recommendation for the 6-Balls WL-CSP Option



WL-CSP Layout Guidelines: This figure shows the recommended layout and placement of the external components for the AS1376B version. Red lines are connections on TOP layer. Grey lines are GND connections on

TOP layer.

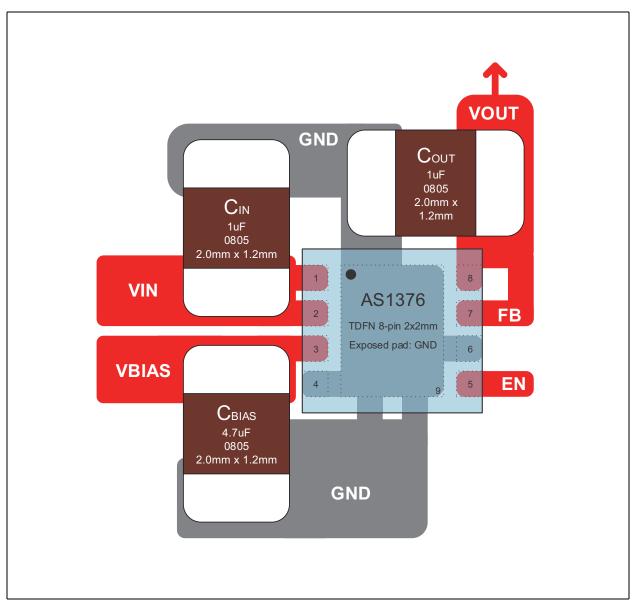


Figure 26: PCB Layout Recommendation for the 8-Pins TDFN Package Option

TDFN Layout Guidelines: This figure shows the recommended layout and placement of the external components for the AS1376 version for fixed trimmed output voltages. Red lines are connections on TOP layer. Grey lines are GND connections on TOP layer.

am



Ordering & Contact Information

Figure 27: Ordering Information

Ordering Code	Package	Marking	Output	Delivery Form	Delivery Quantity
AS1376-BTDT-AD ⁽¹⁾	8-pin 2x2mm TDFN	ABL	Adj.	T&R	1000 pcs/reel
AS1376-BTDT-12	8-pin 2x2mm TDFN	ABT	1.2V	T&R	1000 pcs/reel
AS1376B-BWLT-11	6-balls WL-CSP	D3	1.1V	T&R	12000 pcs/reel
AS1376B-BWLM-11	6-balls WL-CSP	D3	1.1V	T&R	1000 pcs/reel

Ordering Information: Specifies the available variants of AS1376

Note(s):

1. Available on request

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Product Preview	Pre-Development	Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice
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Changes from 2-04 (2015-Aug-16) to current revision 2-06 (2016-Feb-11)	Page			
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Updated Figure 2	3			
Updated Figure 3	4			
Updated Figure 4	5			
Updated Figure 5	5			
Updated Figure 7	8			
Updated Figure 20	23			
2-05 (2016-Feb-05) to 2-06 (2016-Feb-11)				
Updated Figure 2	3			
Updated Figure 3	4			

Note(s):

1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.

2. Correction of typographical errors is not explicitly mentioned.

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